



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	3KB (2K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc57c-04-so

Table of Contents

1.0	General Description.....	5
2.0	PIC16C5X Device Varieties	7
3.0	Architectural Overview	9
4.0	Oscillator Configurations	15
5.0	Reset.....	19
6.0	Memory Organization	25
7.0	I/O Ports	35
8.0	Timer0 Module and TMR0 Register	37
9.0	Special Features of the CPU.....	43
10.0	Instruction Set Summary.....	49
11.0	Development Support.....	61
12.0	Electrical Characteristics - PIC16C54/55/56/57	67
13.0	Electrical Characteristics - PIC16CR54A	79
14.0	Device Characterization - PIC16C54/55/56/57/CR54A	91
15.0	Electrical Characteristics - PIC16C54A	103
16.0	Device Characterization - PIC16C54A	117
17.0	Electrical Characteristics - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B	131
18.0	Device Characterization - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B	145
19.0	Electrical Characteristics - PIC16C54C/C55A/C56A/C57C/C58B 40MHz	155
20.0	Device Characterization - PIC16C54C/C55A/C56A/C57C/C58B 40MHz	165
21.0	Packaging Information.....	171
	Appendix A: Compatibility	182
	On-Line Support.....	187
	Reader Response	188
	Product Identification System	189

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@mail.microchip.com or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

<http://www.microchip.com>

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <http://www.microchip.com>
- Your local Microchip sales office (see last page)
- The Microchip Corporate Literature Center; U.S. FAX: (480) 792-7277

When contacting a sales office or the literature center, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com/cn to receive the most current information on all of our products.

PIC16C5X

NOTES:

5.0 RESET

PIC16C5X devices may be RESET in one of the following ways:

- Power-On Reset (POR)
- $\overline{\text{MCLR}}$ Reset (normal operation)
- $\overline{\text{MCLR}}$ Wake-up Reset (from SLEEP)
- WDT Reset (normal operation)
- WDT Wake-up Reset (from SLEEP)

Table 5-1 shows these RESET conditions for the PCL and STATUS registers.

Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-On Reset (POR), $\overline{\text{MCLR}}$ or WDT Reset. A $\overline{\text{MCLR}}$ or WDT wake-up from SLEEP also results in a device RESET, and not a continuation of operation before SLEEP.

The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits (STATUS <4:3>) are set or cleared depending on the different RESET conditions (Table 5-1). These bits may be used to determine the nature of the RESET.

Table 5-3 lists a full description of RESET states of all registers. Figure 5-1 shows a simplified block diagram of the On-chip Reset circuit.

TABLE 5-1: STATUS BITS AND THEIR SIGNIFICANCE

Condition	$\overline{\text{TO}}$	$\overline{\text{PD}}$
Power-On Reset	1	1
$\overline{\text{MCLR}}$ Reset (normal operation)	u	u
$\overline{\text{MCLR}}$ Wake-up (from SLEEP)	1	0
WDT Reset (normal operation)	0	1
WDT Wake-up (from SLEEP)	0	0

Legend: u = unchanged, x = unknown, – = unimplemented read as '0'.

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH RESET

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on $\overline{\text{MCLR}}$ and WDT Reset
03h	STATUS	PA2	PA1	PA0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	000q quuu

Legend: u = unchanged, x = unknown, q = see Table 5-1 for possible values.

8.1 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

8.1.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 8-5). Therefore, it is necessary for T0CKI to be high for at least $2T_{osc}$ (and a small RC delay of 20 ns) and low for at least $2T_{osc}$ (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least $4T_{osc}$ (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

8.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 8-5 shows the delay from the external clock edge to the timer incrementing.

FIGURE 8-5: TIMER0 TIMING WITH EXTERNAL CLOCK

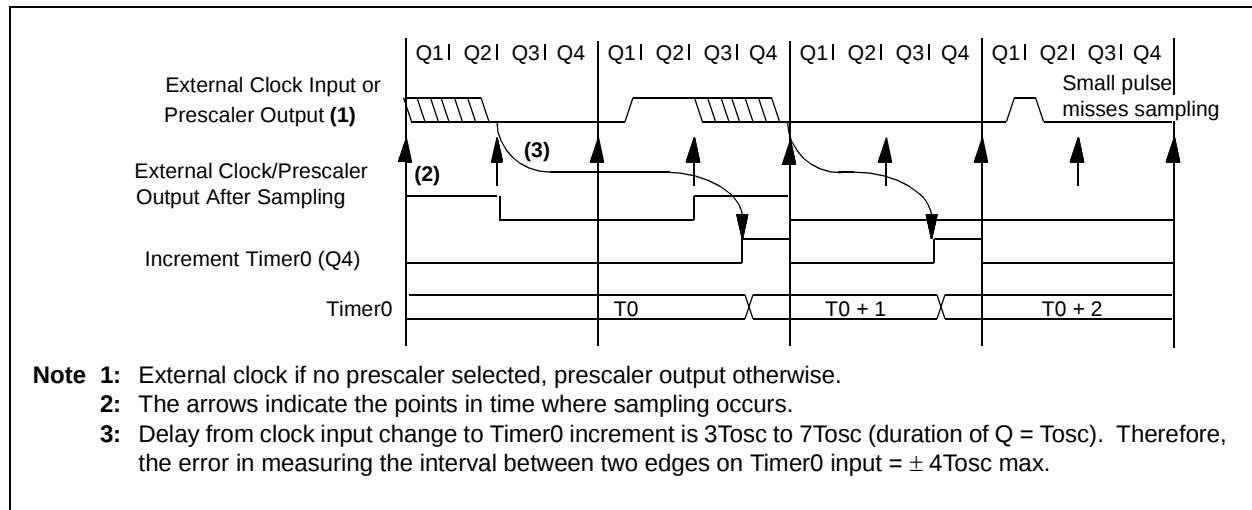
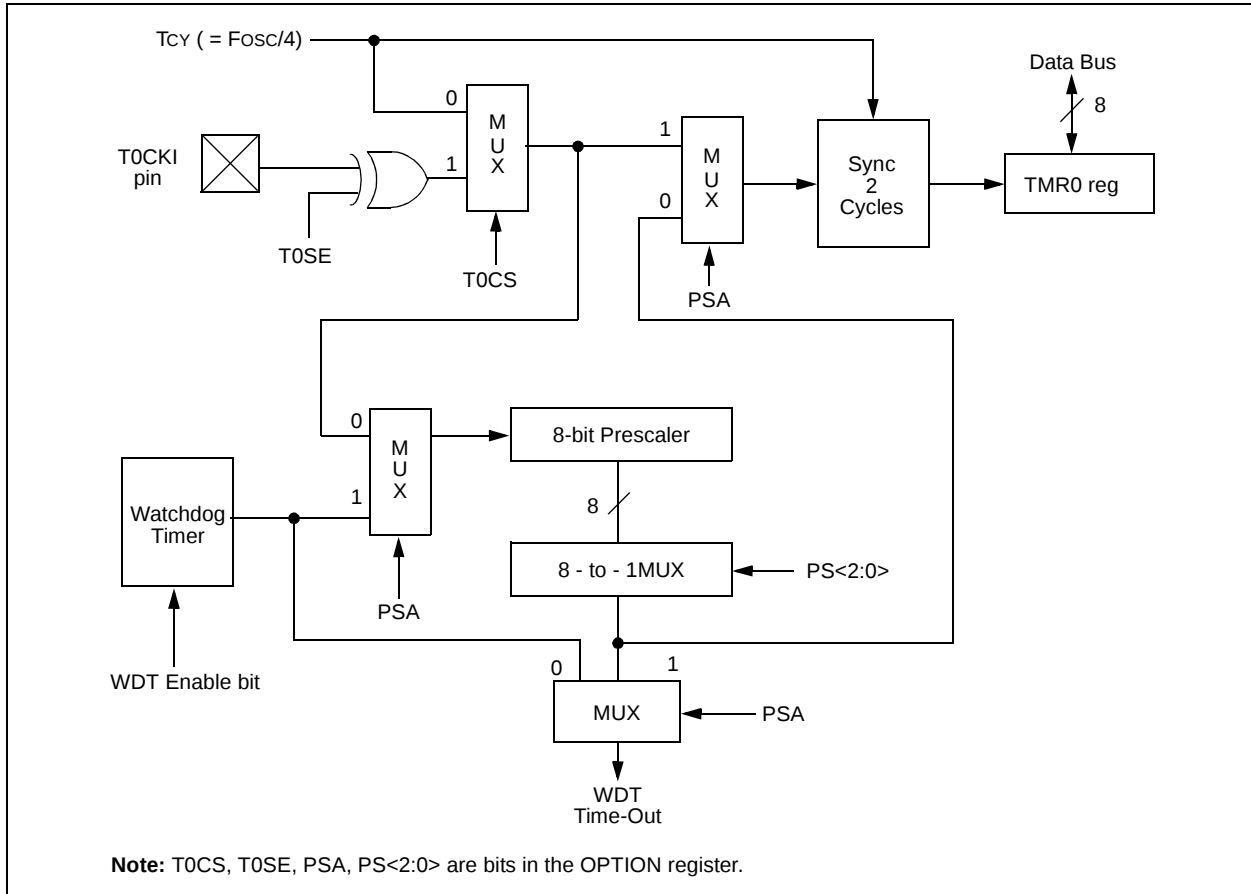


FIGURE 8-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



PIC16C5X

BSF Bit Set f

Syntax: [*label*] BSF f,b
 Operands: $0 \leq f \leq 31$
 $0 \leq b \leq 7$
 Operation: $1 \rightarrow (f < b >)$
 Status Affected: None
 Encoding:

0101	bbbbf	ffff
------	-------	------

 Description: Bit 'b' in register 'f' is set.
 Words: 1
 Cycles: 1
 Example: BSF FLAG_REG, 7

Before Instruction
 FLAG_REG = 0x0A
 After Instruction
 FLAG_REG = 0x8A

BTFSC Bit Test f, Skip if Clear

Syntax: [*label*] BTFSC f,b
 Operands: $0 \leq f \leq 31$
 $0 \leq b \leq 7$
 Operation: skip if $(f < b >) = 0$
 Status Affected: None
 Encoding:

0110	bbbbf	ffff
------	-------	------

 Description: If bit 'b' in register 'f' is 0 then the next instruction is skipped.
 If bit 'b' is 0 then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a 2-cycle instruction.
 Words: 1
 Cycles: 1(2)
 Example: HERE BTFSC FLAG, 1
 FALSE GOTO PROCESS_CODE
 TRUE •
 •
 •

Before Instruction
 PC = address (HERE)
 After Instruction
 if FLAG<1> = 0,
 PC = address (TRUE);
 if FLAG<1> = 1,
 PC = address (FALSE)

BTFSS Bit Test f, Skip if Set

Syntax: [*label*] BTFSS f,b
 Operands: $0 \leq f \leq 31$
 $0 \leq b < 7$
 Operation: skip if $(f < b >) = 1$
 Status Affected: None
 Encoding:

0111	bbbbf	ffff
------	-------	------

 Description: If bit 'b' in register 'f' is '1' then the next instruction is skipped.
 If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a 2-cycle instruction.
 Words: 1
 Cycles: 1(2)

Example: HERE BTFSS FLAG, 1
 FALSE GOTO PROCESS_CODE
 TRUE •
 •
 •

Before Instruction
 PC = address (HERE)
 After Instruction
 If FLAG<1> = 0,
 PC = address (FALSE);
 if FLAG<1> = 1,
 PC = address (TRUE)

GOTO Unconditional Branch

Syntax: [*label*] GOTO *k*

Operands: $0 \leq k \leq 511$

Operation: $k \rightarrow PC<8:0>;$
 $STATUS<6:5> \rightarrow PC<10:9>$

Status Affected: None

Encoding:

101k	kkkk	kkkk
------	------	------

Description: GOTO is an unconditional branch. The 9-bit immediate value is loaded into PC bits <8:0>. The upper bits of PC are loaded from STATUS<6:5>. GOTO is a two-cycle instruction.

Words: 1

Cycles: 2

Example: GOTO THERE

After Instruction
PC = address (THERE)

INCF Increment f

Syntax: [*label*] INCF *f,d*

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest})$

Status Affected: Z

Encoding:

0010	10df	ffff
------	------	------

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Example: INCF CNT, 1

Before Instruction

CNT = 0xFF
Z = 0

After Instruction

CNT = 0x00
Z = 1

INCFSZ Increment f, Skip if 0

Syntax: [*label*] INCFSZ *f,d*

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest}), \text{skip if result} = 0$

Status Affected: None

Encoding:

0011	11df	ffff
------	------	------

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, then the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Example: HERE INCFSZ CNT, 1
GOTO LOOP
CONTINUE •
•
•

Before Instruction

PC = address (HERE)

After Instruction

CNT = CNT + 1;
if CNT = 0,
PC = address (CONTINUE);
if CNT $\neq$ 0,
PC = address (HERE + 1)

MOVWF Move W to f

Syntax: [*label*] MOVWF f
 Operands: $0 \leq f \leq 31$
 Operation: $(W) \rightarrow (f)$
 Status Affected: None
 Encoding:

0000	001f	ffff
------	------	------

 Description: Move data from the W register to register 'f'.
 Words: 1
 Cycles: 1
 Example: MOVWF TEMP_REG

Before Instruction
 TEMP_REG = 0xFF
 W = 0x4F
 After Instruction
 TEMP_REG = 0x4F
 W = 0x4F

NOP No Operation

Syntax: [*label*] NOP
 Operands: None
 Operation: No operation
 Status Affected: None
 Encoding:

0000	0000	0000
------	------	------

 Description: No operation.
 Words: 1
 Cycles: 1
 Example: NOP

OPTION Load OPTION Register

Syntax: [*label*] OPTION
 Operands: None
 Operation: $(W) \rightarrow \text{OPTION}$
 Status Affected: None
 Encoding:

0000	0000	0010
------	------	------

 Description: The content of the W register is loaded into the OPTION register.
 Words: 1
 Cycles: 1
 Example: OPTION

Before Instruction
 W = 0x07
 After Instruction
 OPTION = 0x07

RETLW Return with Literal in W

Syntax: [*label*] RETLW k
 Operands: $0 \leq k \leq 255$
 Operation: $k \rightarrow (W)$;
 TOS $\rightarrow$ PC
 Status Affected: None
 Encoding:

1000	kkkk	kkkk
------	------	------

 Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.
 Words: 1
 Cycles: 2
 Example: CALL TABLE ;W contains
 ;table offset
 ;value.
 • ;W now has table
 • ;value.
 •
 TABLE ADDWF PC ;W = offset
 RETLW k1 ;Begin table
 RETLW k2 ;
 •
 •
 •
 RETLW kn ; End of table

Before Instruction
 W = 0x07
 After Instruction
 W = value of k8

PIC16C5X

12.5 DC Characteristics: PIC16C54/55/56/57-RCE, XTE, 10E, HSE, LPE (Extended)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
D030	V_{IL}	Input Low Voltage					
		I/O ports	V_{SS}	—	$0.15 V_{DD}$	V	Pin at hi-impedance PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP
		MCLR (Schmitt Trigger)	V_{SS}	—	$0.15 V_{DD}$	V	
		T0CKI (Schmitt Trigger)	V_{SS}	—	$0.15 V_{DD}$	V	
		OSC1 (Schmitt Trigger)	V_{SS}	—	$0.15 V_{DD}$	V	
		OSC1 (Schmitt Trigger)	V_{SS}	—	$0.3 V_{DD}$	V	
D040	V_{IH}	Input High Voltage					
		I/O ports	$0.45 V_{DD}$	—	V_{DD}	V	For all V_{DD} ⁽⁴⁾ $4.0\text{V} < V_{DD} \leq 5.5\text{V}$ ⁽⁴⁾ $V_{DD} > 5.5\text{V}$ PIC16C5X-RC only ⁽³⁾ PIC16C5X-XT, 10, HS, LP
		I/O ports	2.0	—	V_{DD}	V	
		I/O ports	$0.36 V_{DD}$	—	V_{DD}	V	
		MCLR (Schmitt Trigger)	$0.85 V_{DD}$	—	V_{DD}	V	
		T0CKI (Schmitt Trigger)	$0.85 V_{DD}$	—	V_{DD}	V	
		OSC1 (Schmitt Trigger)	$0.85 V_{DD}$	—	V_{DD}	V	
		OSC1 (Schmitt Trigger)	$0.7 V_{DD}$	—	V_{DD}	V	
D050	V_{HYS}	Hysteresis of Schmitt Trigger inputs	$0.15 V_{DD}^*$	—	—	V	
D060	I_{IL}	Input Leakage Current ^(1,2)					For $V_{DD} \leq 5.5\text{V}$: $V_{SS} \leq V_{PIN} \leq V_{DD}$, pin at hi-impedance $V_{PIN} = V_{SS} + 0.25\text{V}$ $V_{PIN} = V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$, PIC16C5X-XT, 10, HS, LP
		I/O ports	–1	0.5	+1	μA	
		MCLR	–5	—	—	μA	
		MCLR	—	0.5	+5	μA	
		T0CKI	–3	0.5	+3	μA	
		OSC1	–3	0.5	+3	μA	
D080	V_{OL}	Output Low Voltage					
		I/O ports	—	—	0.6	V	$I_{OL} = 8.7\text{ mA}$, $V_{DD} = 4.5\text{V}$ $I_{OL} = 1.6\text{ mA}$, $V_{DD} = 4.5\text{V}$, PIC16C5X-RC
		OSC2/CLKOUT	—	—	0.6	V	
D090	V_{OH}	Output High Voltage ⁽²⁾					
		I/O ports	$V_{DD} - 0.7$	—	—	V	$I_{OH} = -5.4\text{ mA}$, $V_{DD} = 4.5\text{V}$ $I_{OH} = -1.0\text{ mA}$, $V_{DD} = 4.5\text{V}$, PIC16C5X-RC
		OSC2/CLKOUT	$V_{DD} - 0.7$	—	—	V	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C . This data is for design guidance only and is not tested.

Note 1: The leakage current on the $\overline{\text{MCLR}}/\text{VPP}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

2: Negative current is defined as coming out of the pin.

3: For PIC16C5X-RC devices, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

4: The user may use the better of the two specifications.

12.6 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

T		T	
F	Frequency	T	Time

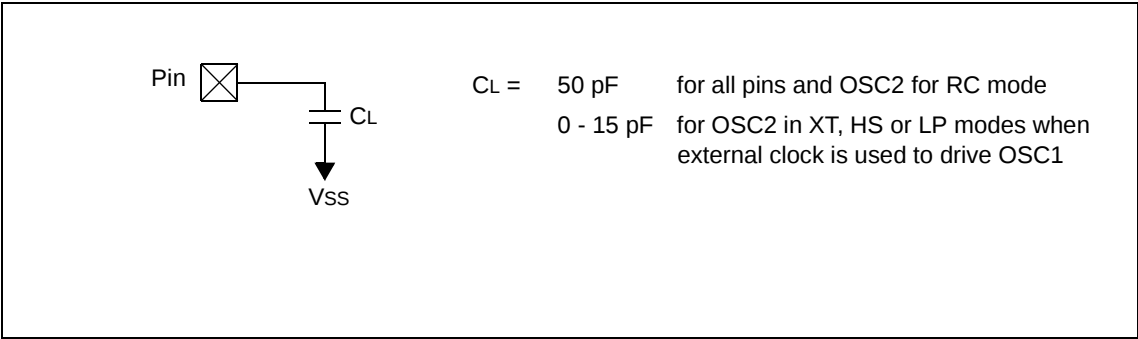
Lowercase letters (pp) and their meanings:

pp		mc	$\overline{\text{MCLR}}$
2	to	osc	oscillator
ck	CLKOUT	os	OSC1
cy	cycle time	t0	T0CKI
drt	device reset timer	wdt	watchdog timer
io	I/O port		

Uppercase letters and their meanings:

S		P	Period
F	Fall	R	Rise
H	High	V	Valid
I	Invalid (Hi-impedance)	Z	Hi-impedance
L	Low		

FIGURE 12-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54/55/56/57



PIC16C5X

FIGURE 12-5: TIMER0 CLOCK TIMINGS - PIC16C54/55/56/57

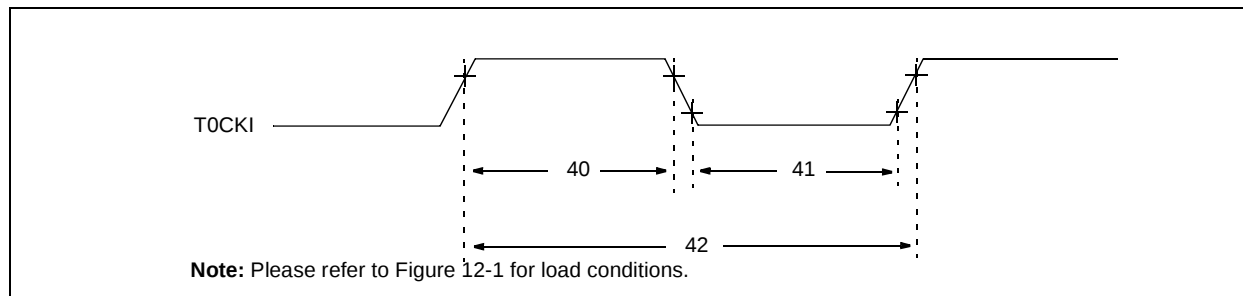


TABLE 12-4: TIMER0 CLOCK REQUIREMENTS - PIC16C54/55/56/57

AC Characteristics		Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
42	Tt0P	T0CKI Period	20 or $\frac{T_{CY} + 40^*}{N}$	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

13.5 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

T		T	Time
F	Frequency		

Lowercase letters (pp) and their meanings:

pp		mc	MCLR
2	to	osc	oscillator
ck	CLKOUT	os	OSC1
cy	cycle time	t0	T0CKI
drt	device reset timer	wdt	watchdog timer
io	I/O port		

Uppercase letters and their meanings:

S		P	Period
F	Fall	R	Rise
H	High	V	Valid
I	Invalid (Hi-impedance)	Z	Hi-impedance
L	Low		

FIGURE 13-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16CR54A

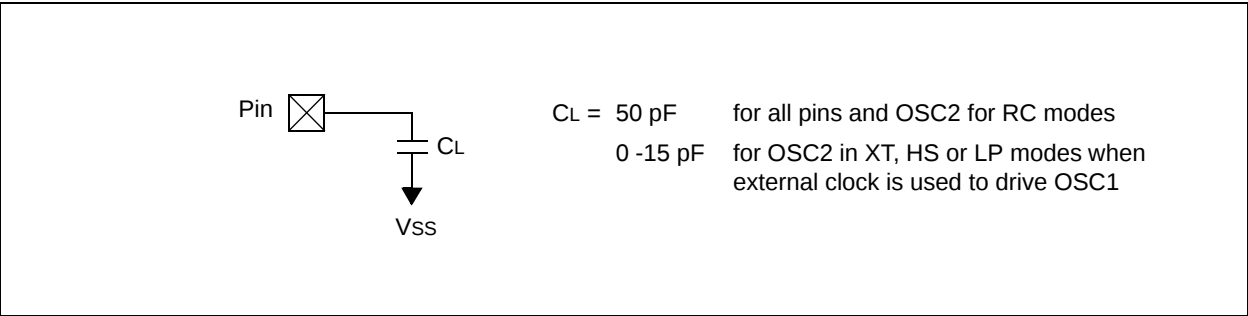


FIGURE 13-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16CR54A

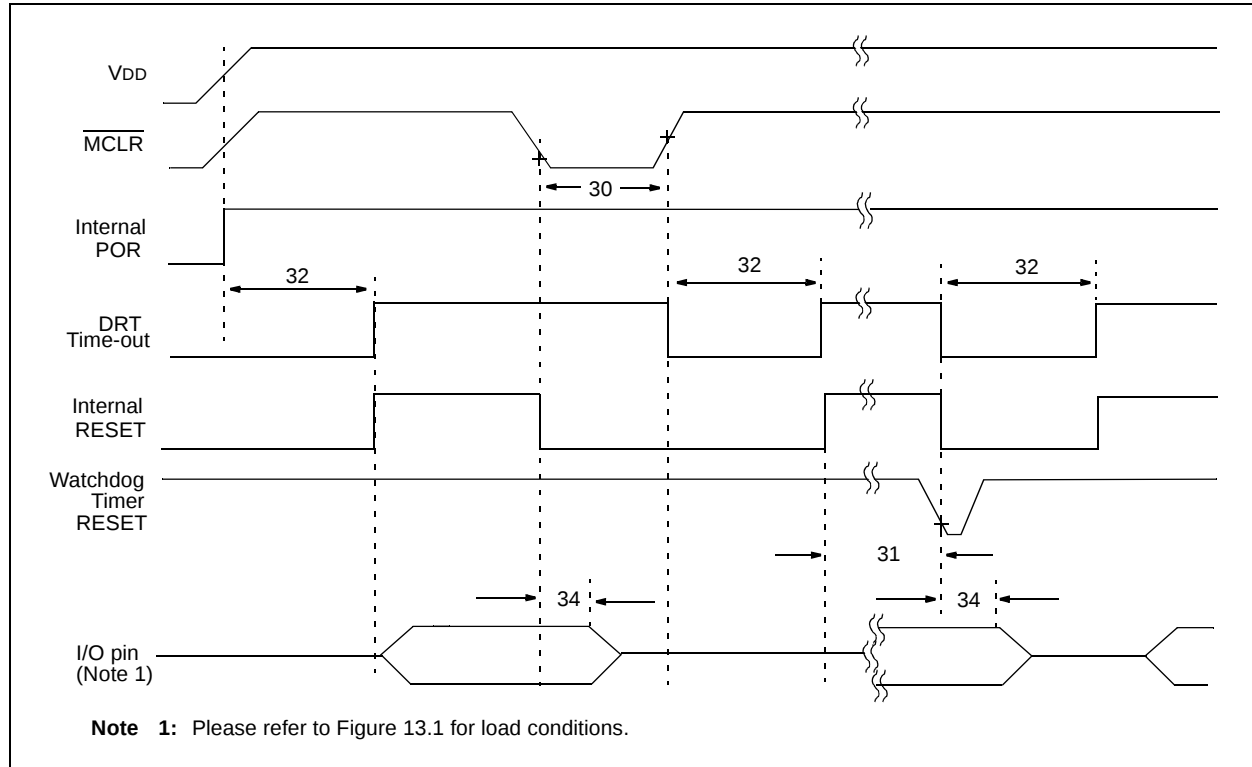


TABLE 13-3: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16CR54A

Standard Operating Conditions (unless otherwise specified)							
AC Characteristics		Operating Temperature					
		0°C ≤ TA ≤ +70°C for commercial					
		–40°C ≤ TA ≤ +85°C for industrial					
		–40°C ≤ TA ≤ +125°C for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmCL	MCLR Pulse Width (low)	1.0*	—	—	μs	VDD = 5.0V
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7.0*	18*	40*	ms	VDD = 5.0V (Comm)
32	TDRT	Device Reset Timer Period	7.0*	18*	30*	ms	VDD = 5.0V (Comm)
34	Tioz	I/O Hi-impedance from MCLR Low	—	—	1.0*	μs	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 16-18: TRANSCONDUCTANCE (gm) OF LP OSCILLATOR vs. VDD

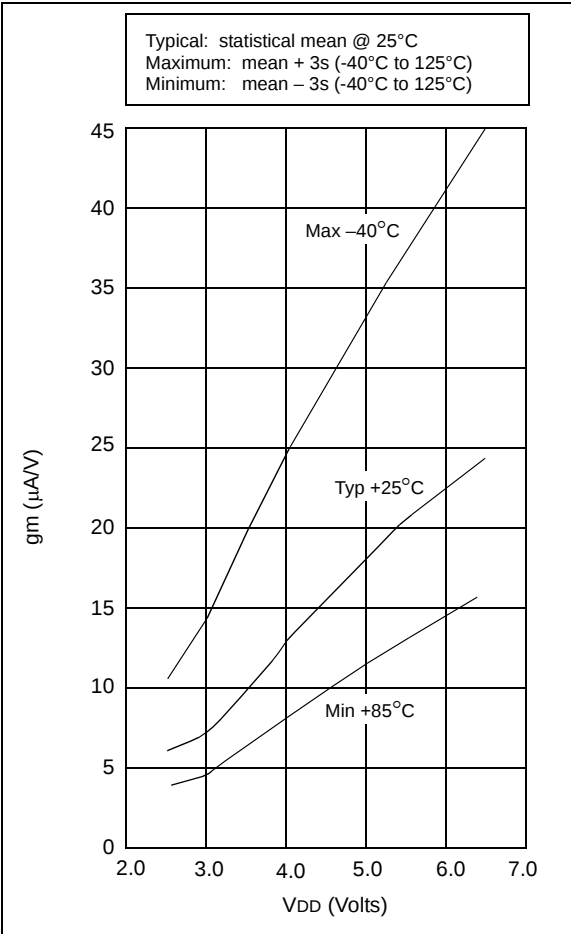
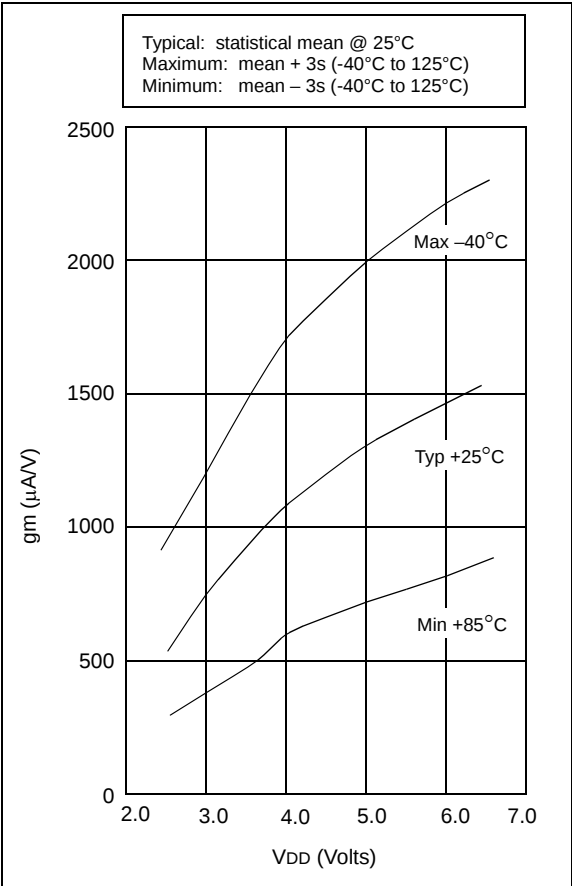


FIGURE 16-19: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD



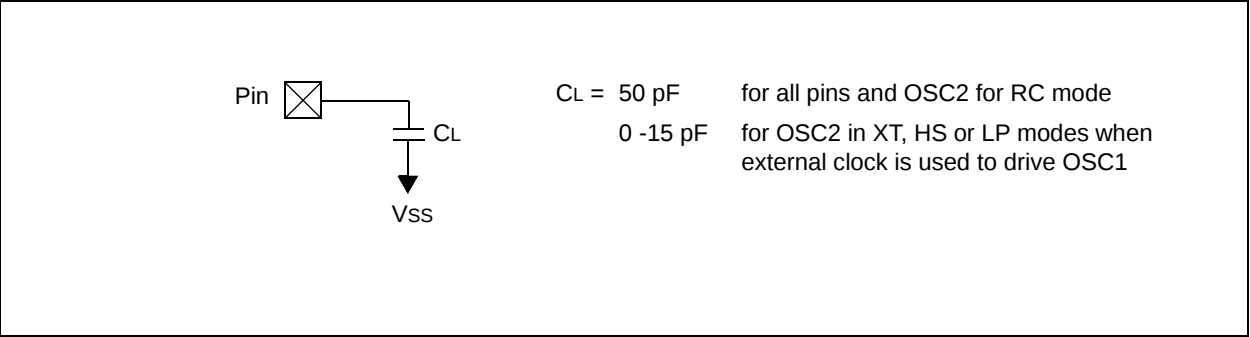
17.4 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

T		T	Time
F	Frequency		
Lowercase letters (pp) and their meanings:			
pp		mc	MCLR
2	to	osc	oscillator
ck	CLKOUT	os	OSC1
cy	cycle time	t0	T0CKI
drt	device reset timer	wdt	watchdog timer
io	I/O port		
Uppercase letters and their meanings:			
S		P	Period
F	Fall	R	Rise
H	High	V	Valid
I	Invalid (Hi-impedance)	Z	Hi-impedance
L	Low		

FIGURE 17-5: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B-04, 20



PIC16C5X

FIGURE 17-7: CLKOUT AND I/O TIMING - PIC16C5X, PIC16CR5X

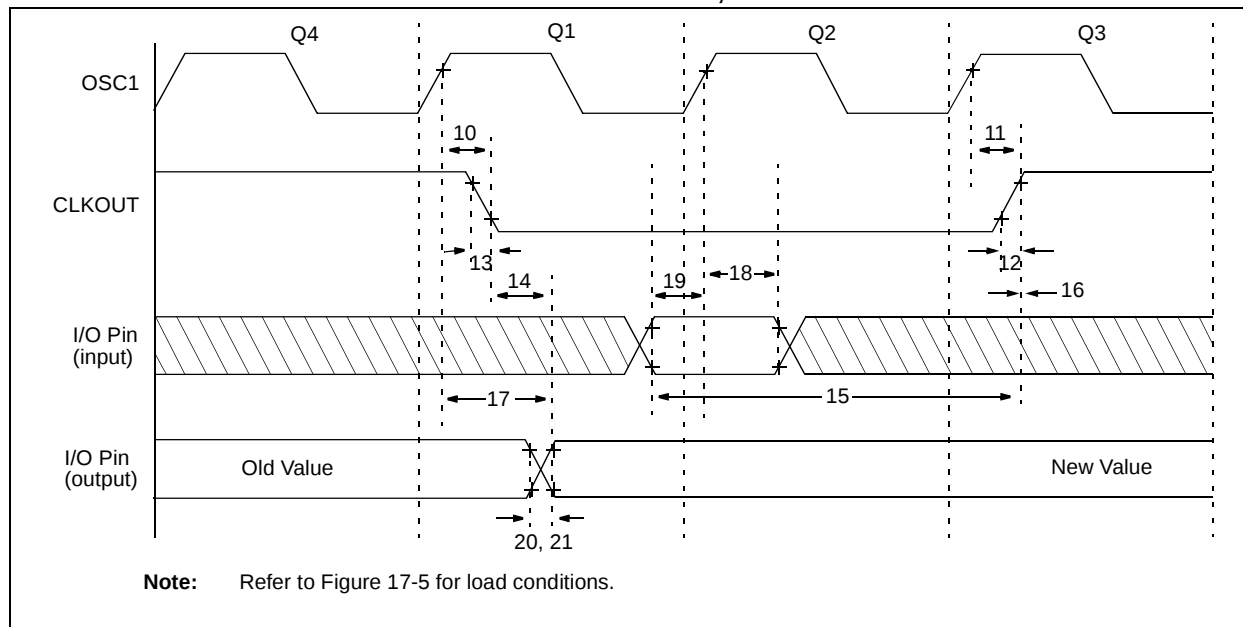


TABLE 17-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X

AC Characteristics		Standard Operating Conditions (unless otherwise specified)				
		Operating Temperature				
		0°C ≤ TA ≤ +70°C for commercial				
		-40°C ≤ TA ≤ +85°C for industrial				
		-40°C ≤ TA ≤ +125°C for extended				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units
10	TosH2ckL	OSC1↑ to CLKOUT↓ ⁽¹⁾	—	15	30**	ns
11	TosH2ckH	OSC1↑ to CLKOUT↑ ⁽¹⁾	—	15	30**	ns
12	TckR	CLKOUT rise time ⁽¹⁾	—	5.0	15**	ns
13	TckF	CLKOUT fall time ⁽¹⁾	—	5.0	15**	ns
14	TckL2ioV	CLKOUT↓ to Port out valid ⁽¹⁾	—	—	40**	ns
15	TioV2ckH	Port in valid before CLKOUT↑ ⁽¹⁾	0.25 TCY+30*	—	—	ns
16	TckH2ioI	Port in hold after CLKOUT↑ ⁽¹⁾	0*	—	—	ns
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid ⁽²⁾	—	—	100*	ns
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns
20	TioR	Port output rise time ⁽²⁾	—	10	25**	ns
21	TioF	Port output fall time ⁽²⁾	—	10	25**	ns

* These parameters are characterized but not tested.

** These parameters are design targets and are not tested. No characterization data available at this time.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

2: Refer to Figure 17-5 for load conditions.

19.1 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-40 (Commercial)⁽¹⁾

PIC16C54C/C55A/C56A/C57C/C58B-40 (Commercial)			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature 0°C ≤ TA ≤ +70°C for commercial				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
D001	VDD	Supply Voltage	4.5	—	5.5	V	HS mode from 20 - 40 MHz
D002	VDR	RAM Data Retention Voltage ⁽²⁾	—	1.5*	—	V	Device in SLEEP mode
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	VSS	—	V	See Section 5.1 for details on Power-on Reset
D004	SVDD	VDD Rise Rate to ensure Power-on Reset	0.05*	—	—	V/ms	See Section 5.1 for details on Power-on Reset
D010	IDD	Supply Current ⁽³⁾	—	5.2 6.8	12.3 16	mA mA	FOSC = 40 MHz, VDD = 4.5V, HS mode FOSC = 40 MHz, VDD = 5.5V, HS mode
D020	IPD	Power-down Current ⁽³⁾	—	1.8 9.8	7.0 27*	μA μA	VDD = 5.5V, WDT disabled, Commercial VDD = 5.5V, WDT enabled, Commercial

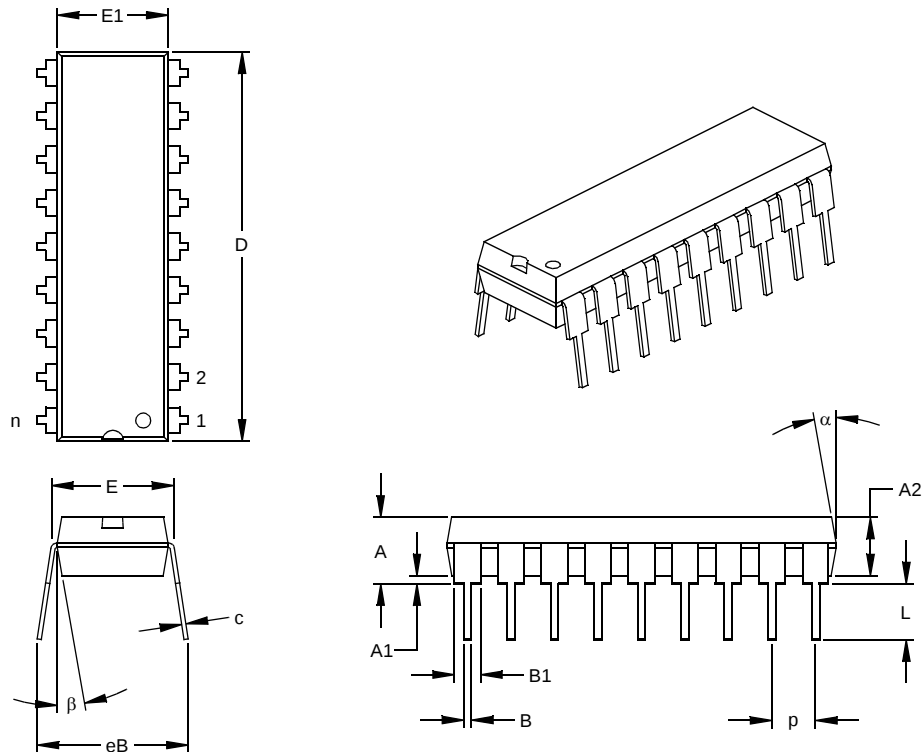
* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

- Note 1:** Device operation between 20 MHz to 40 MHz requires the following: VDD between 4.5V to 5.5V, OSC1 pin externally driven, OSC2 pin not connected, HS oscillator mode and commercial temperatures. For operation between DC and 20 MHz, See Section 19.1.
- 2:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
- 3:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
- a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

18-Lead Plastic Dual In-line (P) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.890	.898	.905	22.61	22.80	22.99
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:

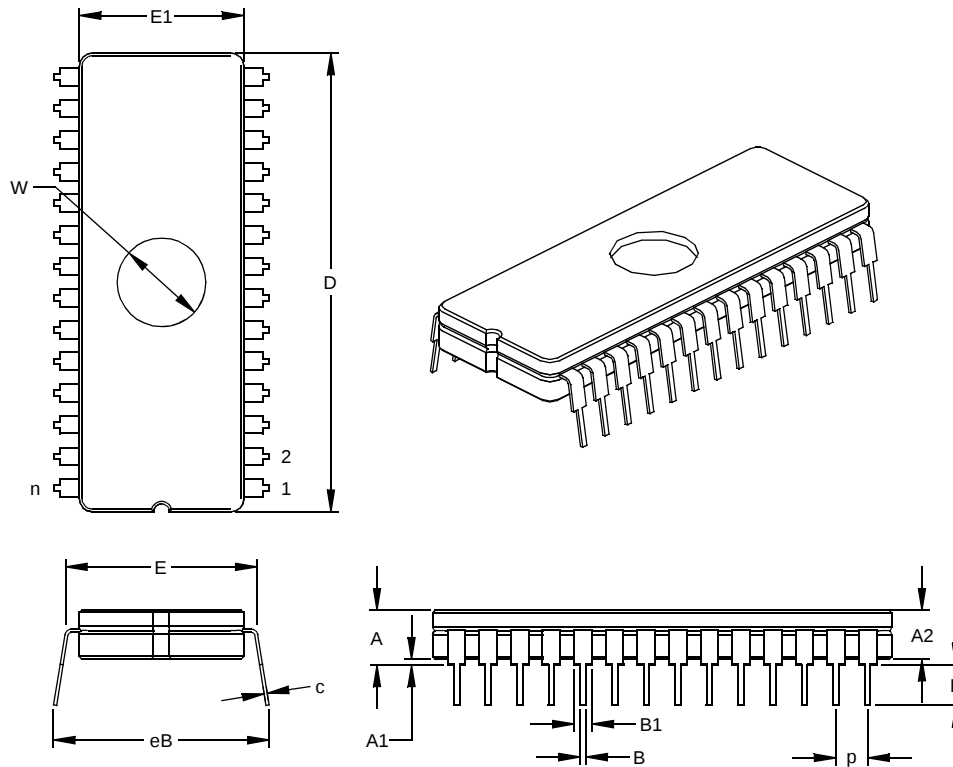
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-001

Drawing No. C04-007

28-Lead Ceramic Dual In-line with Window (JW) – 600 mil (CERDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packages>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.195	.210	.225	4.95	5.33	5.72
Ceramic Package Height	A2	.155	.160	.165	3.94	4.06	4.19
Standoff	A1	.015	.038	.060	0.38	0.95	1.52
Shoulder to Shoulder Width	E	.595	.600	.625	15.11	15.24	15.88
Ceramic Pkg. Width	E1	.514	.520	.526	13.06	13.21	13.36
Overall Length	D	1.430	1.460	1.490	36.32	37.08	37.85
Tip to Seating Plane	L	.125	.138	.150	3.18	3.49	3.81
Lead Thickness	c	.008	.010	.012	0.20	0.25	0.30
Upper Lead Width	B1	.050	.058	.065	1.27	1.46	1.65
Lower Lead Width	B	.016	.020	.023	0.41	0.51	0.58
Overall Row Spacing	§	eB	.610	.660	15.49	16.76	18.03
Window Diameter	W	.270	.280	.290	6.86	7.11	7.37

* Controlling Parameter
 § Significant Characteristic
 JEDEC Equivalent: MO-103
 Drawing No. C04-013

PIC16C5X

M

MCLR Reset	
Register values on	20
Memory Map	
PIC16C54/CR54/C55	25
PIC16C56/CR56	25
PIC16C57/CR57/C58/CR58	25
Memory Organization	25
MOVF	56
MOVLW	56
MOVWF	57
MPLAB C17 and MPLAB C18 C Compilers	61
MPLAB ICD In-Circuit Debugger	63
MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE	62
MPLAB Integrated Development Environment Software	61
MPLINK Object Linker/MPLIB Object Librarian	62

N

NOP	57
-----------	----

O

One-Time-Programmable (OTP) Devices	7
OPTION	57
OPTION Register	30
Value on reset	20
Oscillator Configurations	15
Oscillator Types	
HS	15
LP	15
RC	15
XT	15

P

PA0 bit	29
PA1 bit	29
Paging	31
PC	31
Value on reset	20
PD bit	19, 29
Peripheral Features	1
PICDEM 1 Low Cost PIC MCU Demonstration Board	63
PICDEM 17 Demonstration Board	64
PICDEM 2 Low Cost PIC16CXX Demonstration Board	63
PICDEM 3 Low Cost PIC16CXXX Demonstration Board	64
PICSTART Plus Entry Level Development Programmer	63
Pin Configurations	2
Pinout Description - PIC16C54, PIC16CR54, PIC16C56, PIC16CR56, PIC16C58, PIC16CR58	11
Pinout Description - PIC16C55, PIC16C57, PIC16CR57 ...	12
PORTA	35
Value on reset	20
PORTB	35
Value on reset	20
PORTC	35
Value on reset	20
Power-Down Mode	47
Power-On Reset (POR)	21
Register values on	20
Prescaler	40
PRO MATE II Universal Device Programmer	63
Program Counter	31
Program Memory Organization	25
Program Verification/Code Protection	47

Q

Q cycles	13
Quick-Turnaround-Production (QTP) Devices	7

R

RC Oscillator	17
Read Only Memory (ROM) Devices	7
Read-Modify-Write	36
Register File Map	
PIC16C54, PIC16CR54, PIC16C55, PIC16C56, PIC16CR56	26
PIC16C57/CR57	27
PIC16C58/CR58	27
Registers	
Special Function	28
Value on reset	20
Reset	19
Reset on Brown-Out	23
RETLW	57
RLF	58
RRF	58

S

Serialized Quick-Turnaround-Production (SQTP) Devices...	7
SLEEP	43, 47, 58
Software Simulator (MPLAB SIM)	62
Special Features of the CPU	43
Special Function Registers	28
Stack	32
STATUS Register	9, 29
Value on reset	20
SUBWF	59
SWAPF	59

T

Timer0	
Switching Prescaler Assignment	40
Timer0 (TMR0) Module	37
TMR0 register - Value on reset	20
TMR0 with External Clock	39
Timing Diagrams and Specifications	
PIC16C54/55/56/57	74
PIC16C54A	111
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B	140
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B-40	160
PIC16CR54A	86
Timing Parameter Symbolology and Load Conditions	
PIC16C54/55/56/57	73
PIC16C54A	110
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B	139
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B-40	159
PIC16CR54A	85
TO bit	19, 29
TRIS	59
TRIS Registers	35
Value on reset	20

U

UV Erasable Devices	7
---------------------------	---